

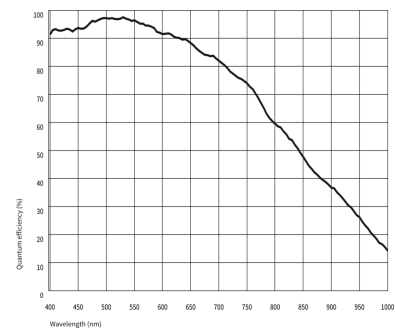
In series
The model is in series and available for the long term.



Specification

Sensor

Sensor type	CMOS Mono
Shutter	Rolling shutter
Sensor characteristic	Linear
Pixel Class	4 MP
Resolution	4.15 Mpix
Resolution (h x v)	2704 x 1536 Pixel
Aspect ratio	16:9
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/1.8"
Optical Size	7.842 mm x 4.454 mm
Optical sensor diagonal	9.02 mm 1/1.8"
Pixel size	2.9 µm
CRA (Chief Ray Angle)	0 °
Manufacturer	Sony
Sensor Model	IMX664-AAMR1-C
Gain (master/RGB)	31.6x/-
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	256 / 2
AOI image height / step width	1 / 1
AOI position grid (horizontal/vertical)	2 / 1
Binning horizontal	increased frame rate
Binning vertical	increased frame rate
Binning method	Horizontal: mean / Vertical: mean
Binning factor	2x2
Decimation (subsampling) horizontal	-
Decimation (subsampling) vertical	-
Decimation (subsampling) method	M/C automatic



Model

Frame rate freerun mode	85 fps
Frame rate trigger (maximum)	-
Exposure time (minimum - maximum)	0.013 ms - 1999 ms
Long exposure (maximum)	120034 ms
Power consumption	2.7 W
Image memory	-

HDR

Mode	ClearHDR
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Ambient conditions

The temperature values given below refer to the outer device temperature of the camera housing.

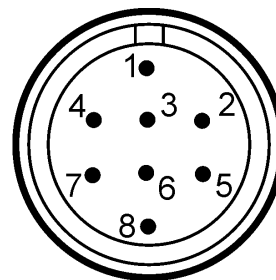
Allowed device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Allowed ambient temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	USB 3.0 micro-B, screwable
I/O connector	8-pin Hirose connector (HR25-7TR-8PA(73))
Power supply	USB cable

Pin assignment I/O connector

1	Ground (GND)
2	Flash output with optocoupler (-) - Line 1
3	General Purpose I/O (GPIO) 1 - Line 2
4	Trigger input with optocoupler (-) - Line 0
5	Flash output with optocoupler (+) - Line 1
6	General Purpose I/O (GPIO) 2
7	Trigger input with optocoupler (+) - Line 0
8	Output supply voltage, 5 V (100 mA)



Design

Lens Mount	C-Mount
IP code	IP30
Dimensions H/W/L	29.0 mm x 29.0 mm x 29.0 mm
Mass	50 g
Housing material	Magnesium / stainless steel

Features

List of on-camera image pre-processing features.

All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

Image Acquisition

Freerun	✓
Software trigger	-
Hardware trigger	-
Trigger controlled exposure	-
Denoiser	✓
Long exposure	✓
Line scan	-
Global start	-

Flashing	Flashing	✓
	PWM flashing	✓
Image Adjustments	Auto exposure	✓
	Auto gain	✓
	Auto whitebalance	-
	Color correction	-
	Gamma	✓
	LUT	✓
	Mirror/flip	X/Y
On-board Image Processing	Pixel formats	Mono8 Mono10 Mono10p Mono12 Mono12p
	Region of interest	✓
	Decimation (FPGA)	✓
	Decimation (Sensor)	
	Binning (FPGA)	✓
	Binning (Sensor)	2x2 Increases frame rate.
Others	Chunks	✓
	Sequencer	-
	Events	✓
	Firmware update	✓
	1st supported firmware version	3.93.27761